



MMIC SURFACE MOUNT

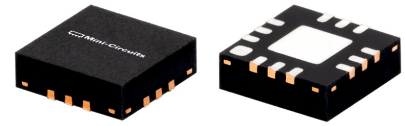
Power Splitter/Combiner

GP2YA+

50 Ω 1600 to 3300 MHz

THE BIG DEAL

- Wide Bandwidth, 1600 to 3300 MHz
- Excellent Insertion Loss, Typ. 1.1 dB
- Excellent Amplitude Unbalance, Typ. 0.03 dB
- Good Phase Unbalance, Typ. 0.6 Deg
- Power Handling as a Splitter, Max 10 W
- 3x3 mm 12-Lead QFN-Style Package

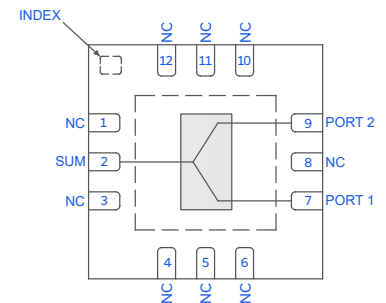


Generic photo used for illustration purposes only

APPLICATIONS

- Back Haul Radio Systems
- Radar, EW, and ECM Defense Systems
- Satellite Communications

FUNCTIONAL DIAGRAM



PRODUCT OVERVIEW

Mini-Circuits' GP2YA+ is a 50 Ω GaAs MMIC 2-way splitter/combiner that operates from 1600 to 3300 MHz. The GP2YA+ provides typical performance of 1.1 dB insertion loss, 22 dB isolation, 0.03 dB amplitude unbalance, and 0.6 deg phase unbalance. In conjunction, it has excellent power handling capabilities of 10 W max as a splitter. This combination of characteristics makes it the perfect device for maintaining signal integrity and low signal distortion during signal splits, while also handling high power RF signals.

KEY FEATURES

Features	Advantages
Low Insertion Loss, Typ. 1.1 dB (Above 3.0 dB Splitter Loss)	Low insertion loss ensures minimized signal power loss through the device, limiting the need for compensating power requirements at the respective outputs.
Excellent Unbalance • Amplitude Unbalance, Typ. 0.03 dB • Phase Unbalance, Typ. 0.6 deg.	Strong unbalance characteristics allow for low signal distortion and maintaining signal integrity when splitting RF signals between respective outputs.
3x3 mm 12-Lead QFN-Style Package	Small footprint saves space in dense layouts while providing low inductance, repeatable transitions, and excellent thermal contact to the PCB. Industry standard packaging allows for ease of assembly in high volume manufacturing processes.



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ELECTRICAL SPECIFICATIONS¹ AT +25°C & P_{IN} = -10 dBm, UNLESS NOTED OTHERWISE

Parameter	Condition (MHz)	Min.	Typ.	Max.	Units
Frequency Range		1600		3300	MHz
Insertion Loss (Above 3.0 dB Splitter Loss)	1600		1.2	1.6	dB
	2500		1.1	1.4	
	3300		1.2	1.6	
Isolation	1600	18	23		dB
	2500	17	22		
	3300	17	22		
Amplitude Unbalance	1600		0.03	0.2	dB
	2500		0.03	0.2	
	3300		0.04	0.2	
Phase Unbalance	1600		0.8	3.0	Degrees
	2500		0.8	4.0	
	3300		1.0	4.0	
Return Loss (Sum Port)	1600		19		dB
	2500		33		
	3300		16		
Return Loss (Ports 1, 2) ²	1600		20		dB
	2500		29		
	3300		21		

1. Tested on Mini-Circuits Characterization Test Board TB-GP2YAC+. See Figure 2. Board loss de-embedded to the device.

2. Typical values displayed are the worst case among Port 1 and Port 2.





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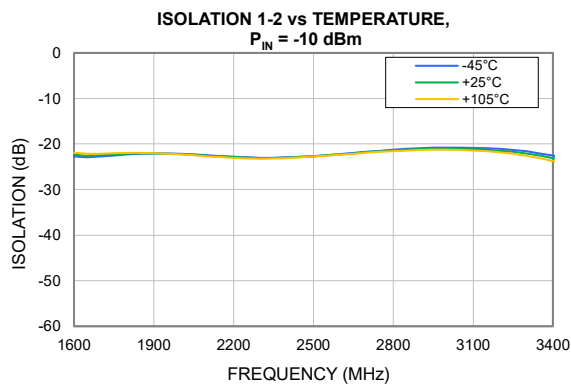
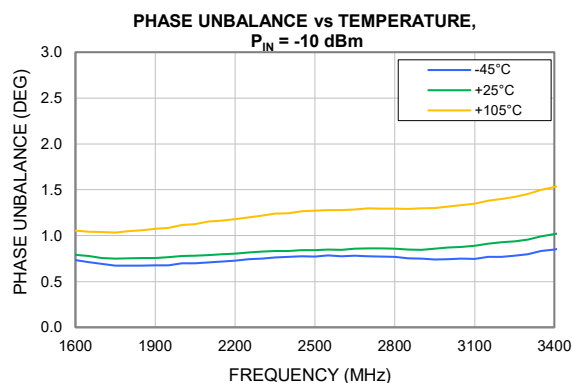
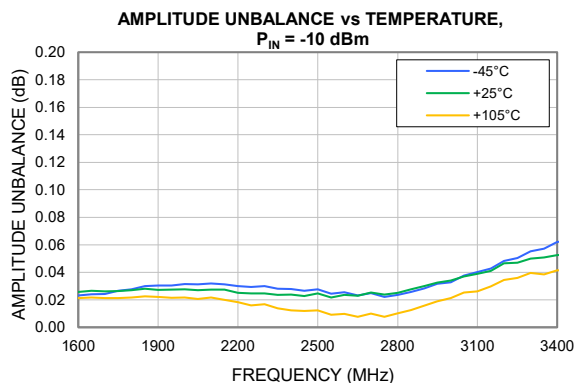
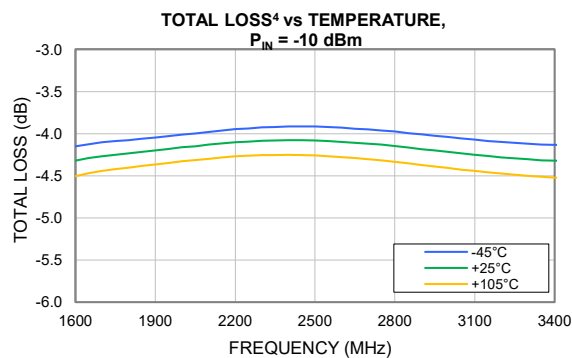
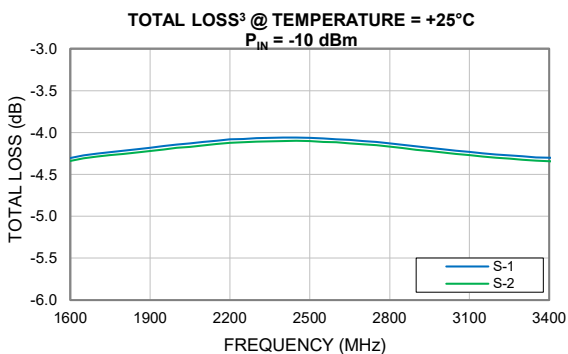
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Power Splitter/Combiner

GP2YA+

50Ω 1600 to 3300 MHz

TYPICAL PERFORMANCE GRAPHS



3. Total Loss = Single Path (S-1 or S-2) Insertion Loss + 3 dB Splitter Loss

4. Average of both paths' Total Loss



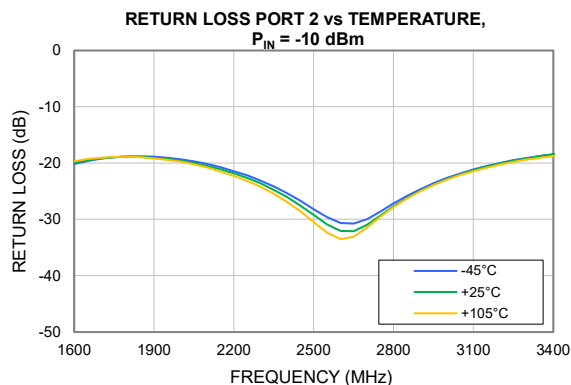
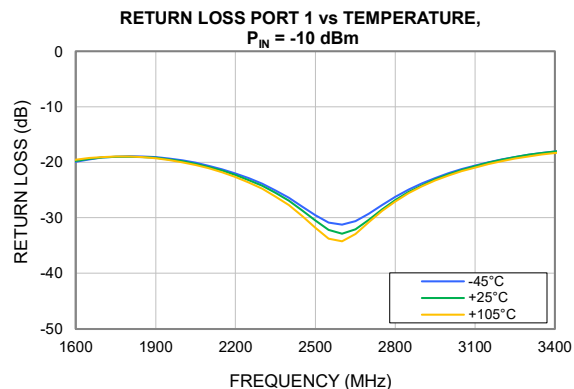
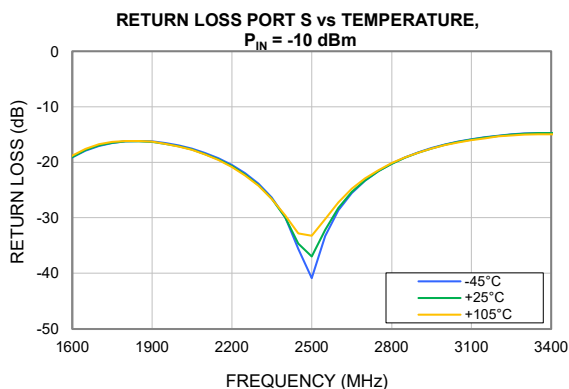
MMIC SURFACE MOUNT

Power Splitter/Combiner

GP2YA+

50 Ω 1600 to 3300 MHz

TYPICAL PERFORMANCE GRAPHS



ABSOLUTE MAXIMUM RATINGS⁵

Parameter	Ratings
Operating Temperature	-45°C to +105°C
Storage Temperature	-65°C to +150°C
Junction Temperature ⁶	+150°C
Power Input (CW) • As a Splitter^{7,8} • As a Combiner^{9,10}	+40 dBm +38 dBm

5. Permanent damage may occur if any of these limits are exceeded. Maximum ratings are not intended for continuous normal operation.

6. Peak temperature on top of Die.

7. Tested by applying input power to Port S, measuring output power at Port 1, and presenting both an Open and 50Ω load at Port 2 to determine worst case conditions.

8. Max power rating at +25°C and +105°C; no derating required over temperature.

9. Tested by applying input power to Port 2, measuring output power at Port 1, and presenting both an Open and 50Ω load at Port S to determine worst case conditions.

10. Derates linearly to +31 dBm at +105°C.

ESD RATING

	Class	Voltage Range	Reference Standard
HBM	1A	250 V to < 500 V	ANSI/ESDA/JEDEC JS-001-2023
CDM	C3	≥ 1000 V	ANSI/ESDA/JEDEC JS-002-2022



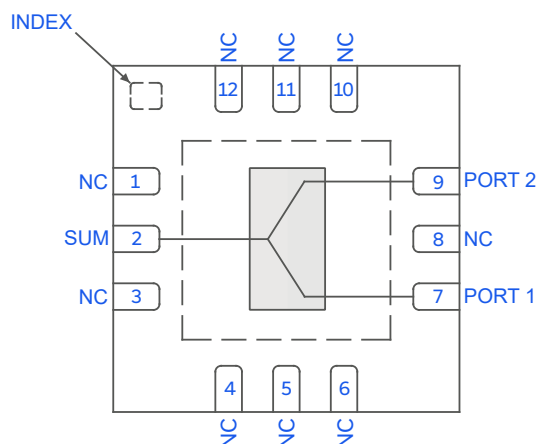
ESD HANDLING PRECAUTION: This device is designed to be Class 1A for HBM. Static charges may easily produce potentials higher than this with improper handling and can discharge into DUT and damage it. As a preventive measure Industry standard ESD handling precautions should be used at all times to protect the device from ESD damage.

MSL RATING

Moisture Sensitivity: MSL1 in accordance with IPC/JEDEC J-STD-020E /JEDEC J-STD-033C



FUNCTIONAL DIAGRAM

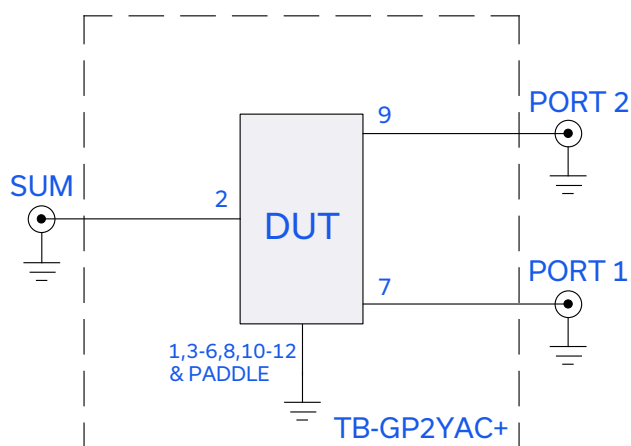


PAD DESCRIPTION

Function	Pad Number	Description (Refer to Figure 2)
SUM	2	SUM Pad connects to Input Sum Port.
PORT 1	7	PORT 1 Pad connects to Output Port 1.
PORT 2	9	PORT 2 Pad connects to Output Port 2.
NC	1, 3-6, 8, 10-12	Connects to ground on the test board.
GND	PADDLE & INDEX	Connects to ground.

Figure 1. GP2YA+ Functional Diagram

CHARACTERIZATION TEST BOARD



Electrical Parameters and Conditions

Insertion Loss, Isolation, Return Loss, Phase Unbalance, and Amplitude Unbalance measured using N5242A PNA-X microwave network analyzer.

Condition:

1) Insertion Loss and Return Loss: $P_{IN} = -10$ dBm

Figure 2. GP2YA+ Characterization and Application Circuit.



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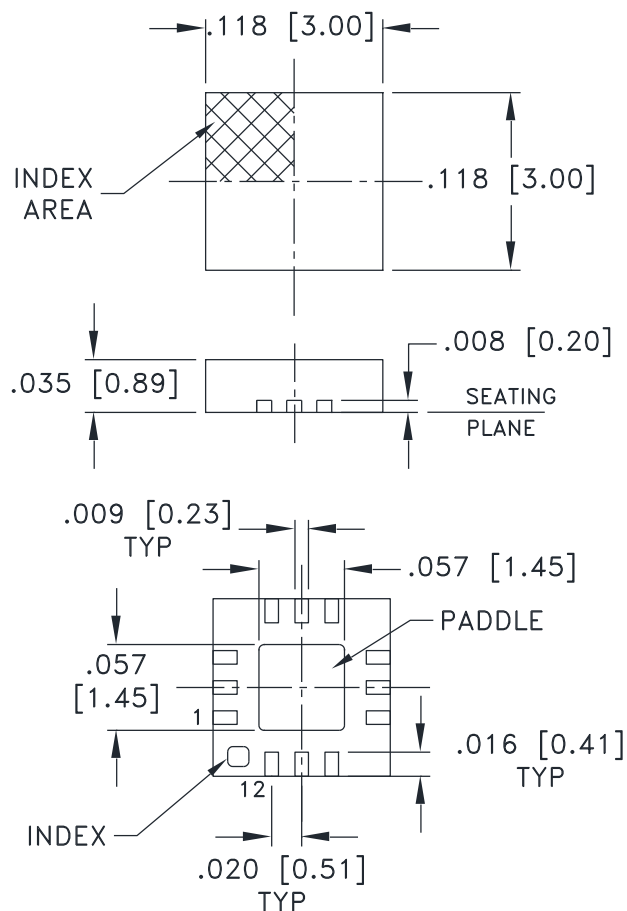
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Power Splitter/Combiner

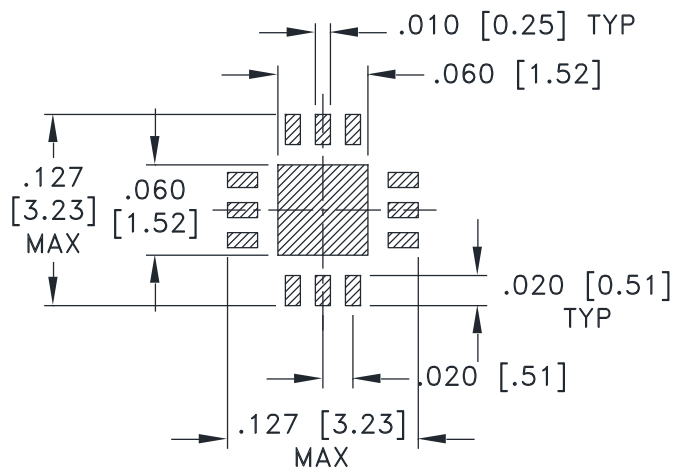
GP2YA+

50Ω 1600 to 3300 MHz

CASE STYLE DRAWING



PCB Land Pattern

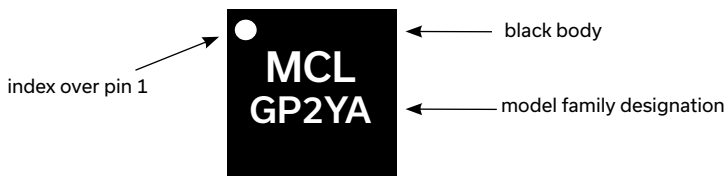


SUGGESTED LAYOUT,
TOLERANCE TO BE WITHIN ± 0.002

Weight: .02 Grams

Dimensions are in inches [mm]. Tolerances in inches: 2 Pl. ± 0.01 ; 3 Pl. ± 0.004 inches

PRODUCT MARKING



Marking may contain other features or characters for internal lot control



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Power Splitter/Combiner

GP2YA+

50Ω 1600 to 3300 MHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD

[CLICK HERE](#)

Performance Data & Graphs	Data
	Graphs
	S-Parameter (S3P Files) Data Set (.zip file)
Case Style	DQ1225 Plastic package, exposed paddle, Lead Finish: Matte-Tin
RoHS Status	Compliant
Tape & Reel Standard quantities available on reel	F66 7" reels with 20, 50, 100, 200, 500, 1000, 2000, or 3000 devices
Suggested Layout for PCB Design	PL-817
Evaluation Board	TB-GP2YAC+
	Gerber File
Environmental Ratings	ENV12

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



Typical Performance Data

NOTE: Use PDF Bookmarks to view DATA at required conditions

Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: P_{IN} = -10 dBm @ Temperature = +25°C

FREQ	Total Loss ¹		Amp. Unbal.	Phase Unbal.	Isolation 1-2	Return Loss		
	S-1	S-2				S	1	2
(MHz)	(dB)	(dB)	(dB)	(Deg.)	(dB)	(dB)	(dB)	(dB)
1600	4.30	4.34	0.03	0.79	22.3	19.1	19.8	20.0
1650	4.27	4.31	0.03	0.78	22.6	17.8	19.4	19.5
1700	4.25	4.29	0.03	0.76	22.5	16.9	19.1	19.1
1750	4.23	4.27	0.03	0.75	22.3	16.5	19.0	18.9
1800	4.22	4.25	0.03	0.75	22.1	16.2	19.0	18.9
1850	4.20	4.23	0.03	0.76	22.0	16.2	19.0	18.9
1900	4.18	4.22	0.03	0.76	22.1	16.3	19.2	19.0
1950	4.16	4.20	0.03	0.77	22.1	16.6	19.5	19.3
2000	4.14	4.18	0.03	0.78	22.3	17.1	19.8	19.6
2050	4.13	4.17	0.03	0.78	22.4	17.7	20.2	20.0
2100	4.11	4.15	0.03	0.79	22.6	18.5	20.8	20.5
2150	4.10	4.14	0.03	0.80	22.7	19.5	21.5	21.1
2200	4.08	4.12	0.03	0.80	22.9	20.7	22.3	21.8
2250	4.08	4.12	0.02	0.82	23.0	22.2	23.2	22.6
2300	4.07	4.11	0.02	0.83	23.1	24.1	24.2	23.6
2350	4.06	4.10	0.02	0.83	23.1	26.5	25.5	24.7
2400	4.06	4.10	0.02	0.83	23.0	29.9	26.9	26.0
2450	4.06	4.10	0.02	0.84	22.9	34.6	28.6	27.5
2500	4.06	4.10	0.02	0.84	22.7	37.0	30.5	29.2
2550	4.07	4.11	0.02	0.85	22.5	32.2	32.2	30.9
2600	4.08	4.12	0.02	0.85	22.3	28.2	32.8	32.1
2650	4.09	4.13	0.02	0.86	22.0	25.3	32.1	32.1
2700	4.10	4.14	0.03	0.86	21.8	23.3	30.4	31.0
2750	4.11	4.15	0.02	0.86	21.6	21.6	28.5	29.4
2800	4.13	4.17	0.02	0.86	21.4	20.3	26.8	27.7
2850	4.15	4.18	0.03	0.85	21.3	19.2	25.3	26.2
2900	4.16	4.20	0.03	0.85	21.1	18.3	24.1	25.0
2950	4.18	4.22	0.03	0.86	21.1	17.5	23.1	23.8
3000	4.20	4.24	0.03	0.87	21.0	16.9	22.2	22.9
3050	4.22	4.26	0.04	0.88	21.1	16.3	21.4	22.0
3100	4.23	4.27	0.04	0.89	21.2	15.9	20.7	21.3
3150	4.25	4.29	0.04	0.91	21.3	15.5	20.1	20.6
3200	4.26	4.30	0.05	0.93	21.5	15.2	19.5	20.0
3250	4.27	4.31	0.05	0.94	21.7	15.0	19.1	19.6
3300	4.28	4.32	0.05	0.96	22.1	14.8	18.7	19.1
3350	4.30	4.34	0.05	0.99	22.5	14.7	18.3	18.8
3400	4.30	4.34	0.05	1.02	23.1	14.7	18.0	18.5

1. Total Loss = Single Path (S-1 or S-2) Insertion Loss + 3 dB Splitter Loss

Typical Performance Data

Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: $P_{IN} = -10$ dBm @ Temperature = -45°C

FREQ	Total Loss ¹		Amp. Unbal.	Phase Unbal.	Isolation 1-2	Return Loss		
	S-1	S-2				S	1	2
(MHz)	(dB)	(dB)	(dB)	(Deg.)	(dB)	(dB)	(dB)	(dB)
1600	4.14	4.17	0.02	0.74	22.7	19.1	19.9	20.1
1650	4.11	4.14	0.02	0.71	23.0	17.9	19.5	19.6
1700	4.09	4.12	0.02	0.69	22.8	17.0	19.1	19.2
1750	4.07	4.10	0.03	0.68	22.5	16.5	19.0	19.0
1800	4.06	4.09	0.03	0.67	22.3	16.2	18.9	18.8
1850	4.05	4.08	0.03	0.67	22.1	16.1	18.9	18.8
1900	4.03	4.06	0.03	0.68	22.1	16.2	19.0	18.9
1950	4.01	4.05	0.03	0.68	22.1	16.5	19.3	19.0
2000	3.99	4.03	0.03	0.70	22.2	17.0	19.6	19.3
2050	3.98	4.01	0.03	0.70	22.3	17.5	20.1	19.7
2100	3.96	4.00	0.03	0.71	22.5	18.3	20.6	20.2
2150	3.95	3.98	0.03	0.72	22.6	19.3	21.3	20.7
2200	3.93	3.96	0.03	0.73	22.8	20.5	22.0	21.4
2250	3.92	3.96	0.03	0.74	22.9	22.0	22.9	22.2
2300	3.91	3.94	0.03	0.75	23.0	23.9	23.9	23.1
2350	3.90	3.94	0.03	0.76	23.0	26.4	25.1	24.2
2400	3.90	3.93	0.03	0.77	23.0	29.8	26.4	25.3
2450	3.90	3.93	0.03	0.77	22.8	35.6	28.0	26.7
2500	3.90	3.93	0.03	0.77	22.7	40.9	29.5	28.2
2550	3.91	3.94	0.02	0.79	22.5	33.3	30.8	29.6
2600	3.91	3.95	0.03	0.77	22.2	28.6	31.2	30.6
2650	3.92	3.96	0.02	0.78	22.0	25.5	30.6	30.7
2700	3.93	3.97	0.02	0.78	21.7	23.3	29.3	29.9
2750	3.95	3.98	0.02	0.77	21.5	21.6	27.7	28.6
2800	3.96	3.99	0.02	0.77	21.3	20.2	26.2	27.2
2850	3.98	4.01	0.03	0.75	21.1	19.1	24.9	25.9
2900	3.99	4.03	0.03	0.75	20.9	18.2	23.8	24.6
2950	4.01	4.04	0.03	0.74	20.8	17.4	22.8	23.6
3000	4.03	4.06	0.03	0.74	20.8	16.8	22.0	22.7
3050	4.04	4.07	0.04	0.75	20.8	16.3	21.2	21.9
3100	4.06	4.09	0.04	0.75	20.8	15.8	20.6	21.1
3150	4.07	4.10	0.04	0.77	20.9	15.5	20.0	20.5
3200	4.08	4.12	0.05	0.77	21.1	15.2	19.5	20.0
3250	4.10	4.13	0.05	0.78	21.3	15.0	19.0	19.5
3300	4.10	4.14	0.06	0.80	21.6	14.8	18.6	19.1
3350	4.11	4.15	0.06	0.83	22.0	14.7	18.3	18.7
3400	4.12	4.15	0.06	0.85	22.6	14.7	18.0	18.4

1. Total Loss = Single Path (S-1 or S-2) Insertion Loss + 3 dB Splitter Loss

Typical Performance Data

Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

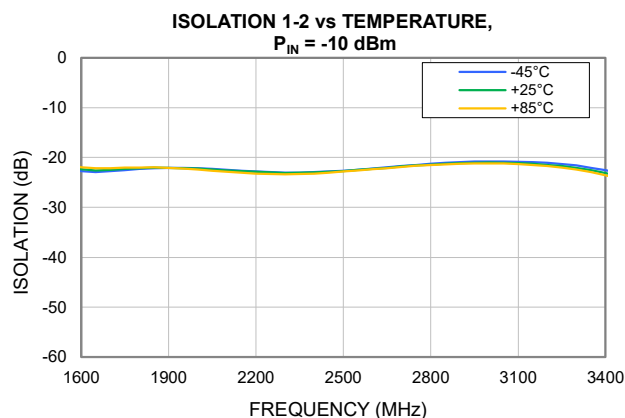
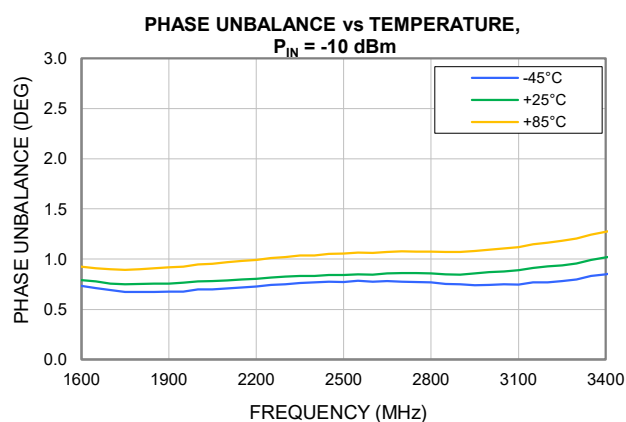
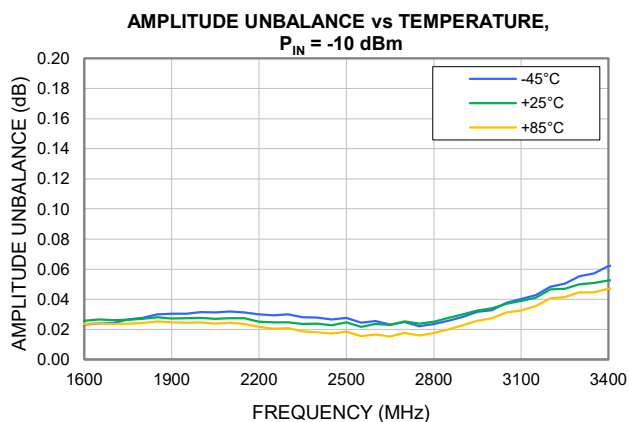
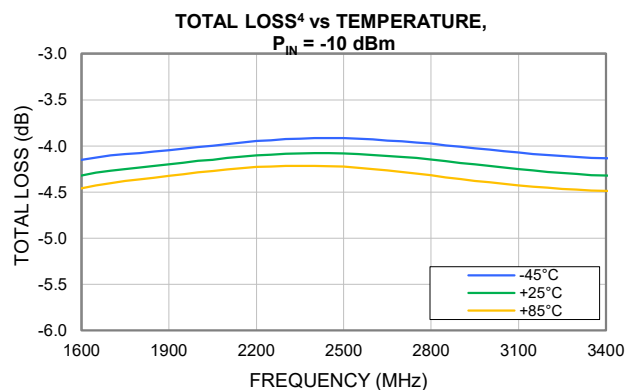
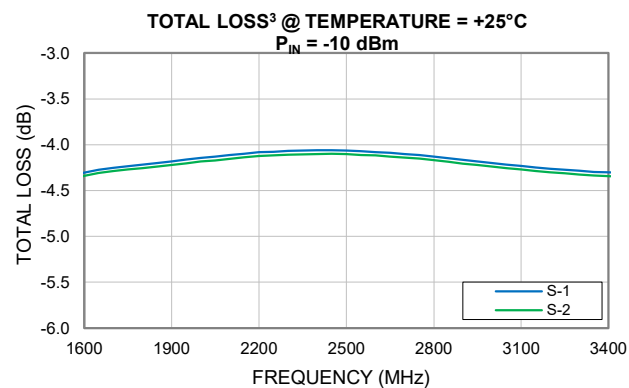
Output Return Loss = -S22 (dB)

TEST CONDITIONS: $P_{IN} = -10$ dBm @ Temperature = +85°C

FREQ	Total Loss ¹		Amp. Unbal.	Phase Unbal.	Isolation 1-2	Return Loss		
	S-1	S-2				S	1	2
(MHz)	(dB)	(dB)	(dB)	(Deg.)	(dB)	(dB)	(dB)	(dB)
1600	4.45	4.48	0.02	0.92	21.9	18.5	19.4	19.6
1650	4.41	4.44	0.02	0.91	22.2	17.3	19.1	19.2
1700	4.39	4.42	0.02	0.90	22.1	16.6	18.9	18.9
1750	4.37	4.40	0.02	0.89	22.0	16.2	18.9	18.8
1800	4.35	4.38	0.02	0.90	22.0	16.0	18.9	18.8
1850	4.33	4.36	0.03	0.91	22.0	16.0	19.0	18.9
1900	4.31	4.34	0.02	0.92	22.1	16.2	19.3	19.1
1950	4.29	4.32	0.02	0.93	22.2	16.6	19.6	19.4
2000	4.27	4.30	0.02	0.95	22.4	17.1	20.1	19.9
2050	4.26	4.29	0.02	0.95	22.6	17.8	20.6	20.4
2100	4.24	4.27	0.02	0.97	22.9	18.7	21.3	21.1
2150	4.23	4.26	0.02	0.98	23.0	19.8	22.1	21.8
2200	4.21	4.24	0.02	0.99	23.2	21.2	23.1	22.8
2250	4.21	4.24	0.02	1.01	23.3	23.0	24.2	23.9
2300	4.20	4.23	0.02	1.02	23.4	25.2	25.6	25.2
2350	4.20	4.23	0.02	1.04	23.3	28.3	27.3	26.8
2400	4.20	4.23	0.02	1.04	23.2	32.7	29.3	28.8
2450	4.20	4.23	0.02	1.05	23.0	35.6	31.8	31.2
2500	4.21	4.24	0.02	1.06	22.8	33.0	33.9	33.2
2550	4.22	4.25	0.02	1.06	22.6	29.2	34.3	33.5
2600	4.24	4.26	0.02	1.06	22.4	26.1	33.1	32.6
2650	4.25	4.28	0.02	1.07	22.1	23.7	31.2	31.2
2700	4.27	4.30	0.02	1.08	21.9	21.9	29.1	29.4
2750	4.29	4.31	0.02	1.08	21.7	20.5	27.2	27.6
2800	4.31	4.33	0.02	1.08	21.5	19.3	25.6	26.0
2850	4.33	4.36	0.02	1.07	21.4	18.3	24.3	24.6
2900	4.35	4.38	0.02	1.07	21.3	17.5	23.2	23.5
2950	4.36	4.39	0.03	1.08	21.2	16.8	22.2	22.5
3000	4.38	4.41	0.03	1.09	21.2	16.2	21.4	21.6
3050	4.40	4.43	0.03	1.11	21.2	15.8	20.7	20.9
3100	4.41	4.44	0.03	1.12	21.3	15.4	20.1	20.3
3150	4.43	4.46	0.04	1.15	21.5	15.1	19.5	19.7
3200	4.44	4.47	0.04	1.17	21.7	14.8	19.1	19.2
3250	4.45	4.48	0.04	1.18	22.0	14.7	18.7	18.8
3300	4.45	4.49	0.04	1.21	22.4	14.6	18.3	18.5
3350	4.47	4.50	0.04	1.25	22.9	14.5	18.0	18.2
3400	4.47	4.51	0.05	1.27	23.6	14.6	17.8	18.0

1. Total Loss = Single Path (S-1 or S-2) Insertion Loss + 3 dB Splitter Loss

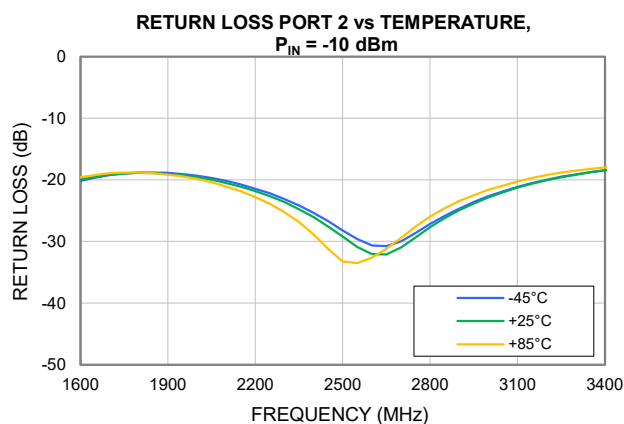
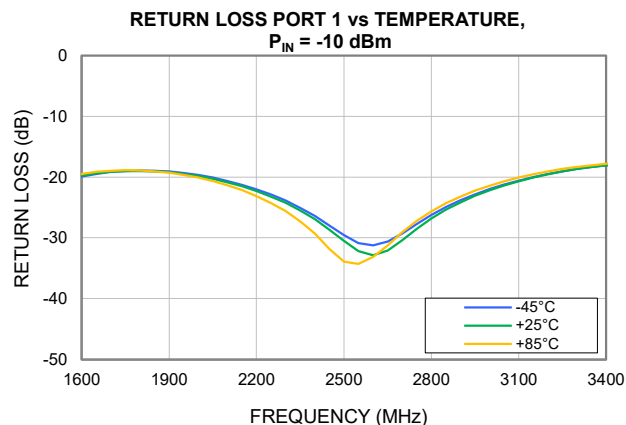
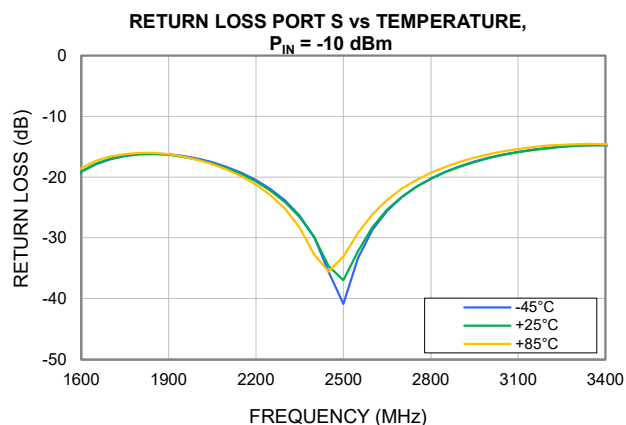
Typical Performance Curves



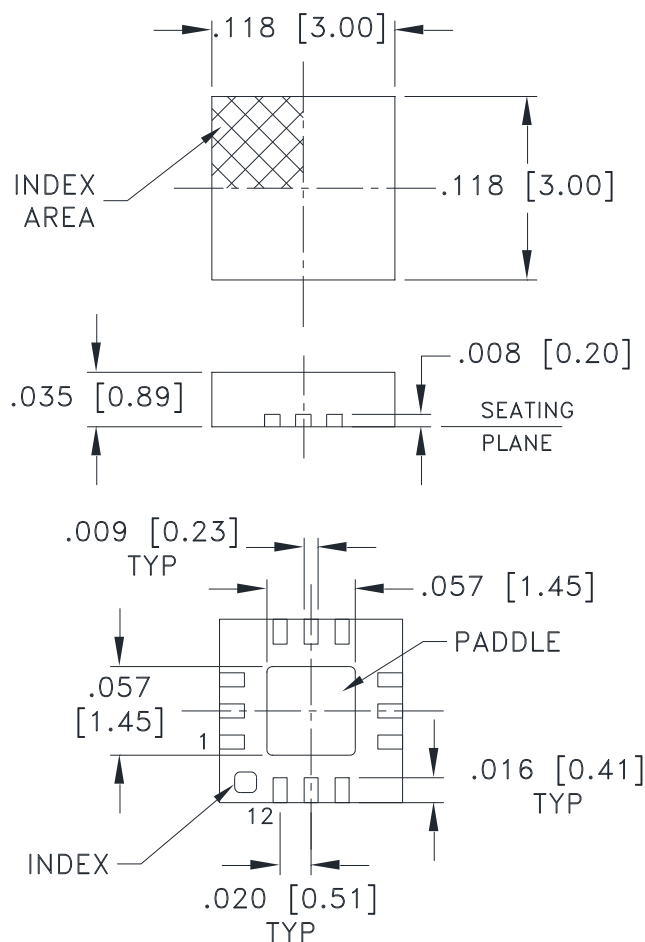
3. Total Loss = Single Path (S-1 or S-2) Insertion Loss + 3 dB Splitter Loss

4. Average of both paths' Total Loss

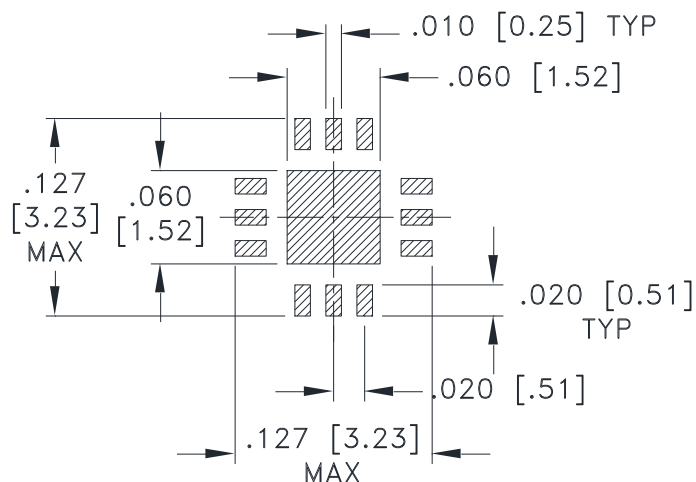
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



SUGGESTED LAYOUT,
TOLERANCE TO BE WITHIN ± 0.002

Weight: .02 Grams

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .004$

Notes:

1. Case material: Plastic.
2. Termination finish:
 - For RoHS Case Styles: Tin-Silver alloy plate over Nickel barrier or Matte-Tin. All models, (+) suffix. See Data sheet.
 - For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



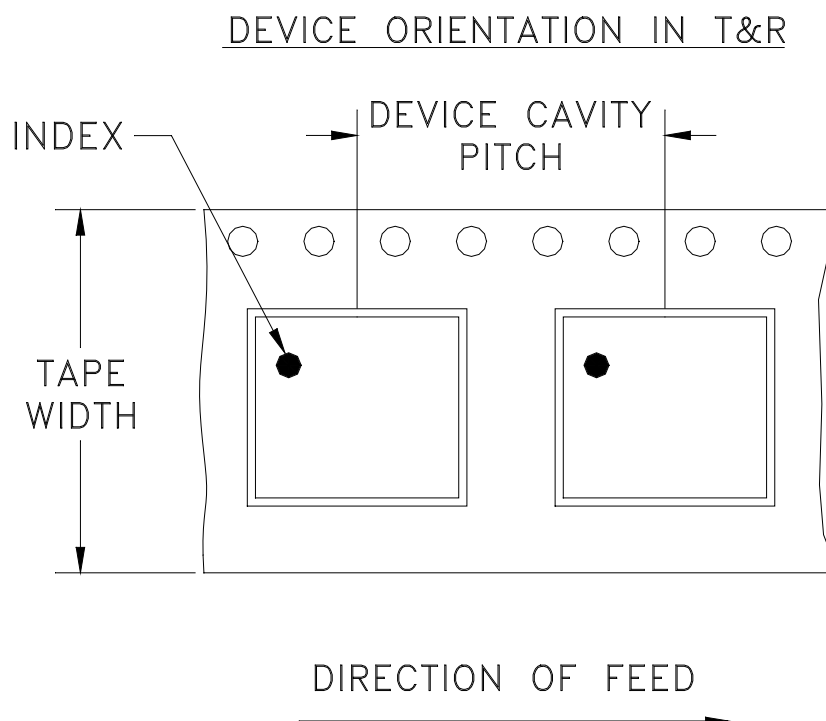
INTERNET <http://www.minicircuits.com>

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Tape & Reel Packaging TR-F66



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
8	4	7	Small quantity standard	20
				50
				100
				200
				500
		7	Standard	1000, 2000, 3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

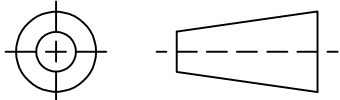


INTERNET <http://www.minicircuits.com>

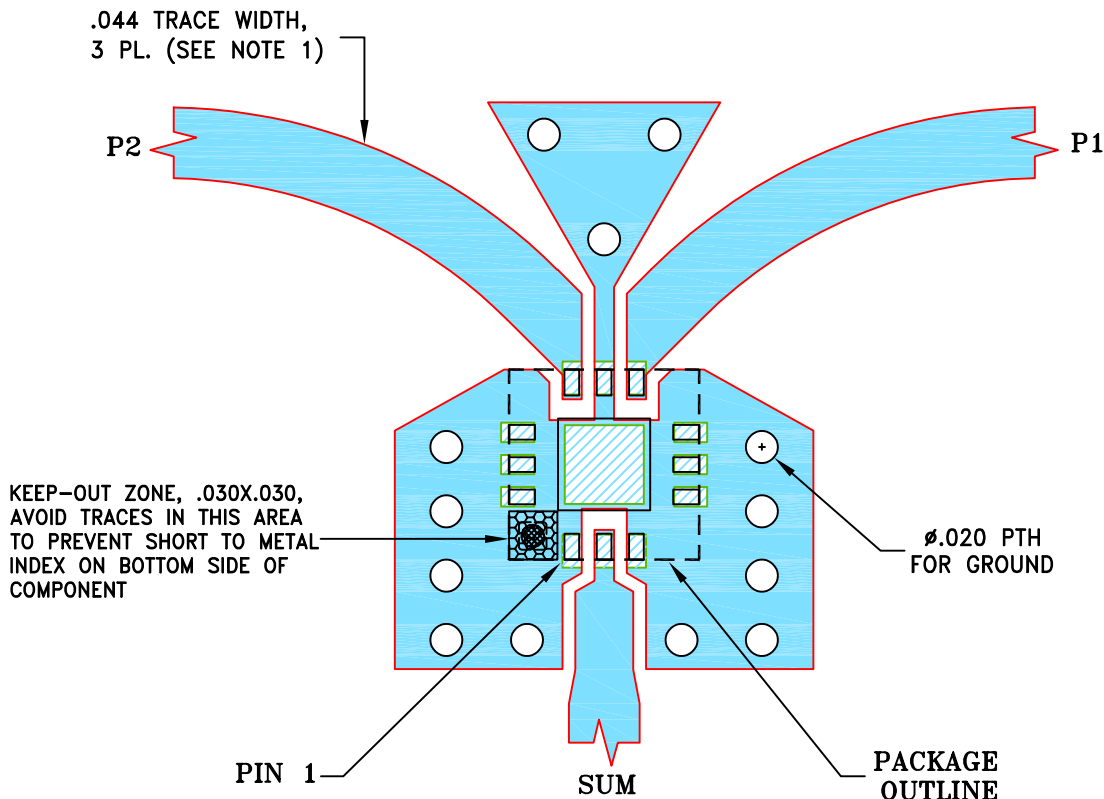
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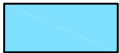
THIRD ANGLE PROJECTION		REVISIONS				
	REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
	OR	EC0-024737	NEW RELEASE	03/12/25	ITG	QT

SUGGESTED MOUNTING CONFIGURATION FOR
DQ1225 CASE STYLE



NOTES:

- TRACE WIDTH IS SHOWN FOR ROGERS R04350B, DIELECTRIC THICKNESS: .020";
COPPER: 1/2 Oz EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- 98-PL-817 IS APPLICABLE FOR CATALOG MODELS GP2SA+, GP2S1A+, GP2YA+ & GP2Y1A+.



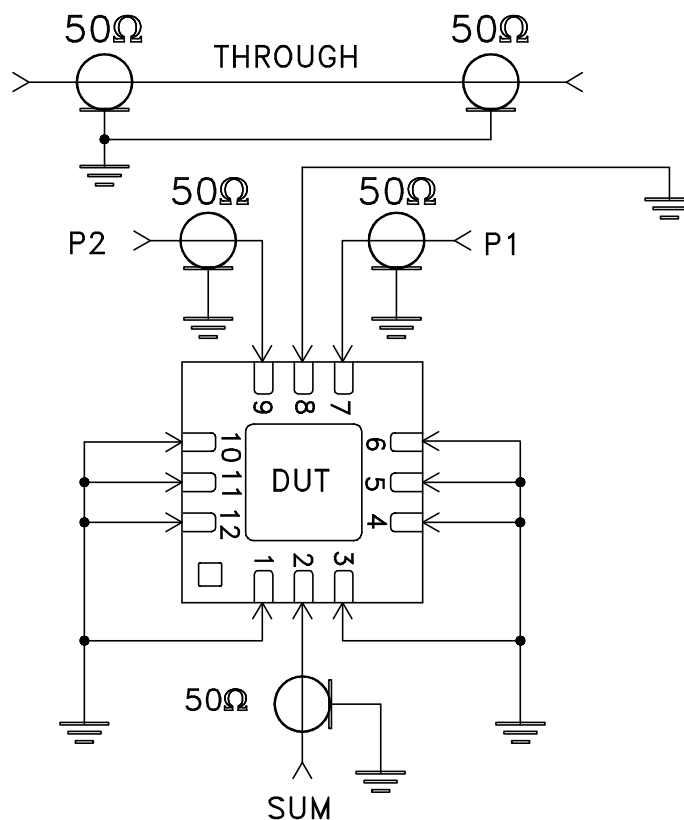
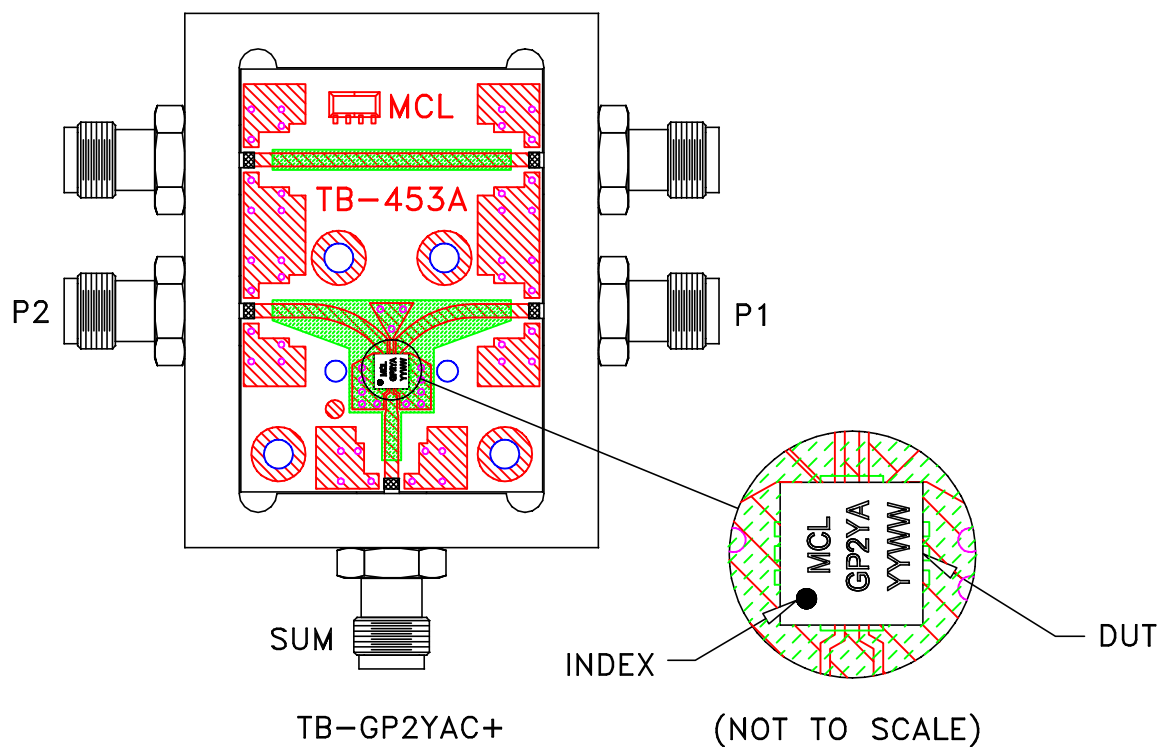
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS		DATE		Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235							
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ± 		DRAWN	ITG	03/12/25		PL, DQ1225, TB-453+							
		CHECKED	GF	03/12/25									
		APPROVED	IL	03/12/25									
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		A		15542		98-PL-817		OR					
		FILE: 98PL817				SCALE: 8:1		SHEET: 1 OF 1					
		ASHEETA1.DWG REV:A DATE:01/12/95											

Evaluation Board and Circuit



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C or -45° to 85° C or -55° to 105° C or -40° to 105° C or -40° to 95° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C or -65° to 150° Ambient Environment	Individual Model Data Sheet
HTOL	1000 hours at 125°C	MIL-STD-883, Method 1005, Condition B
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Mechanical Shock	1.5Kg, 0.5 ms, 5 shock pulses, Y1 direction only	MIL-STD-883, Method 2002, Condition B, except Y1 direction only
Vibration (Variable Frequency)	50g peak	MIL-STD-883, Method 2007, Condition B
Autoclave	15 psig, 100% RH, 121°C, 96 hours	JESD22-A102, Condition C
HAST	130°C, 85% RH, 96 hours	JESD22-A110
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Solder Reflow Heat	Sn-Pb Eutetic Process: 240°C peak Pb-Free Process: 260°C peak	J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1
Moisture Sensitivity: Level 1	Bake at 125°C for 24 hours Soak at 85°C/85% RH for 168 hours, Reflow 3 cycles at 260°C peak	J-STD-020



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215